







## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Batent Application of:

Wing-Cheong Gilbert Lai et al.

SMALL GRAIN SIZE, CONFORMAL ALUMINUM INTERCONNECTS AND METHOD FOR

THEIR FORMATION

Attorney Docket No.: 303.261US2



## PATENT APPLICATION TRANSMITTAL

## BOX PATENT APPLICATION

Commissioner for Patents Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

Χ Return postcard.

- **DIVISIONAL** of prior Patent Application No. <u>09/146,509</u> (under 37 CFR § 1.53(b)) comprising: Χ
  - Specification ( 17 pgs, including claims numbered 1 through 36 and a 1 page Abstract). X
  - Formal Drawing(s) (<u>3</u> sheets). Χ
  - X Copy of signed Declaration (3 pgs) from prior application.
  - Χ Copy of Power of Attorney from prior application (1 pg.)
  - Incorporation by Reference: The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
  - Check in the amount of \$710.00 to pay the filing fee.
- Prior application is assigned of record to Micron Technology, Inc.  $\mathbf{X}$
- Information Disclosure Statement (1 pg), Form 1449 (1 pg). References NOT enclosed, cited in prior application. X
- X Preliminary Amendment (1 pg).

The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	7 - 20 =	0	x 18 =	\$0.00
INDEPENDENT CLAIMS	2 - 3 =	0	x 80 =	\$0.00
[ ] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$710.00
TOTAL				\$710.00

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